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ERU chokes

B82559\*A025

Helically wound

ERU 25

SMD**Rated inductance 0.44 .... 20  $\mu$ H****Saturation current 15 ... 71 A****Construction**

- High temperature ferrite core
- Magnetically shielded
- Helical winding
- Self-leaded construction
- Under body termination

**Features**

- High rated current
- Extremely low DC resistance
- Very low profile and extremely small footprint
- Suitable for pick-and-place processes
- RoHS-compatible
- Easily customized

**Applications**

Energy storage chokes for

- DC/DC converters
- VRM modules
- POL converters
- Solar converters

**Terminals**

Lead-free tinned

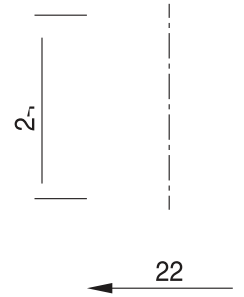
**Marking**

Manufacturer, ordering code, date of manufacture and production place (YYWWD/X),

**Delivery mode and packing units**

- Tray
- Blister tape on request

## Dimensional drawing and layout recommendation



Dimensions in mm

## Packing (tray)

Height (mm)		Packing unit	
component h	tray H	per tray	per box
9.6	19	40	280
11.1	21	40	280
12.8	23	40	240
14.6	23	40	240

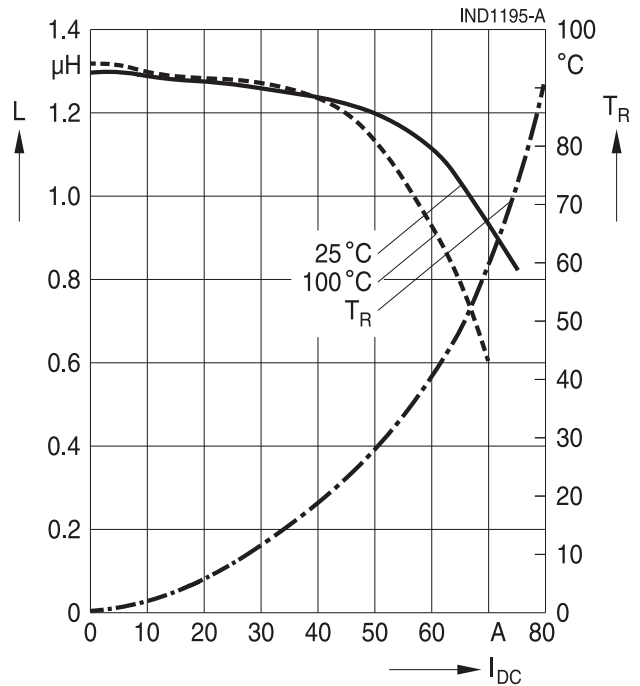


**Inductance L versus DC load current I<sub>DC</sub>**

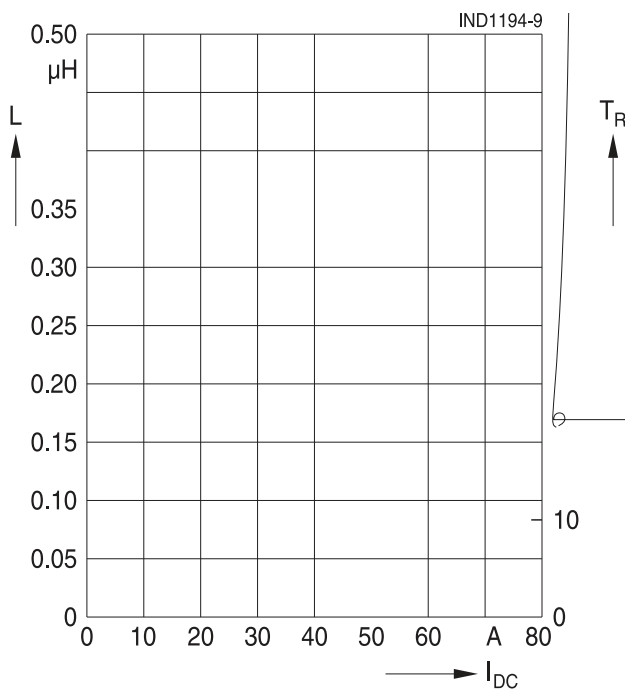
The temperature rise  $\Delta T$  is measured at an ambient temperature of +25 °C. A current is applied for 30 minutes and the temperature is measured via a thermocouple placed on top of the device. No forced air cooling is applied.

The inductance vs current curves are generated by measuring the chokes at +25 °C and +100 °C.

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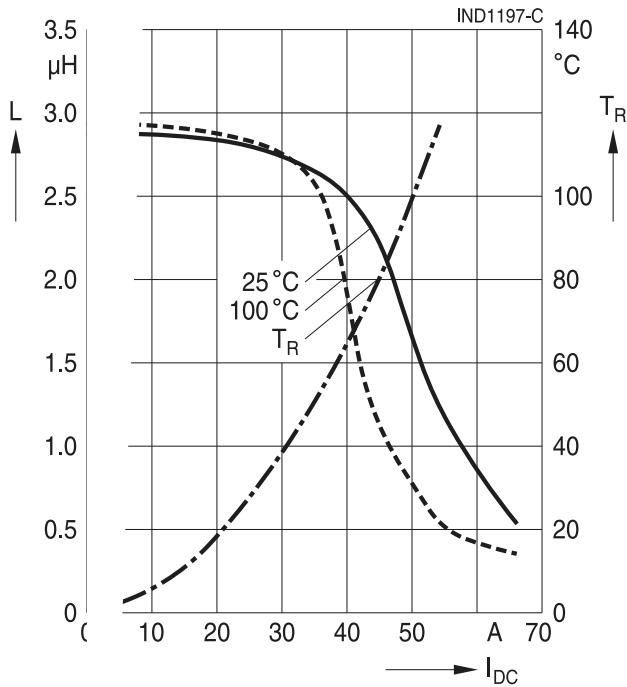


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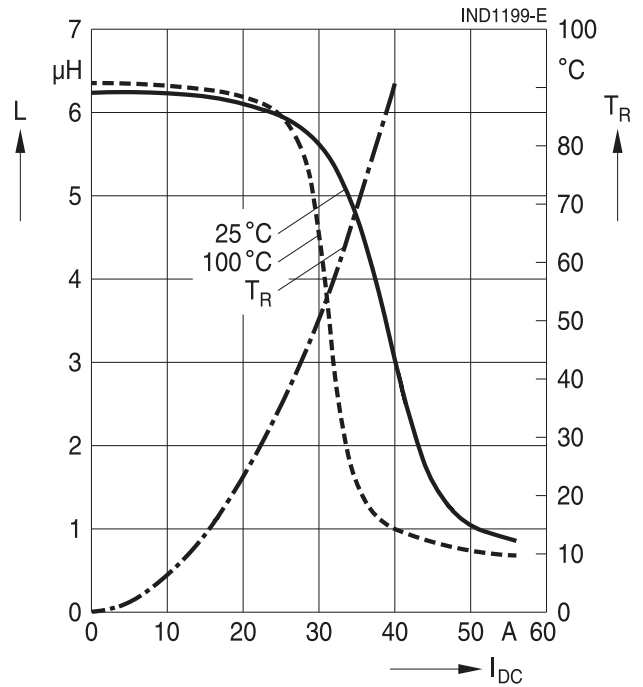


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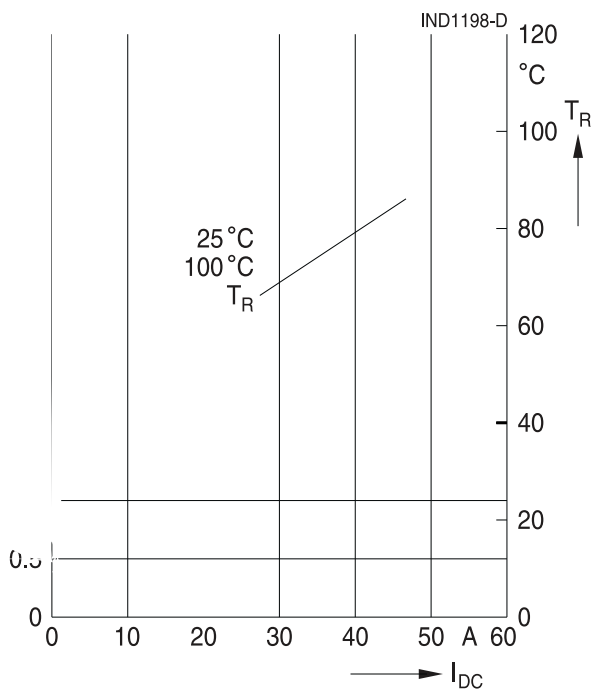
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**B82559A5612A025**



**B82559A4432A025**

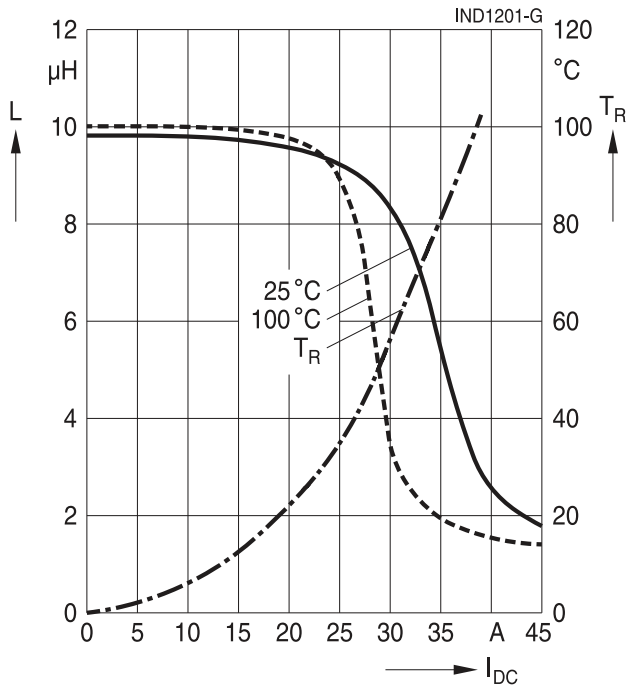


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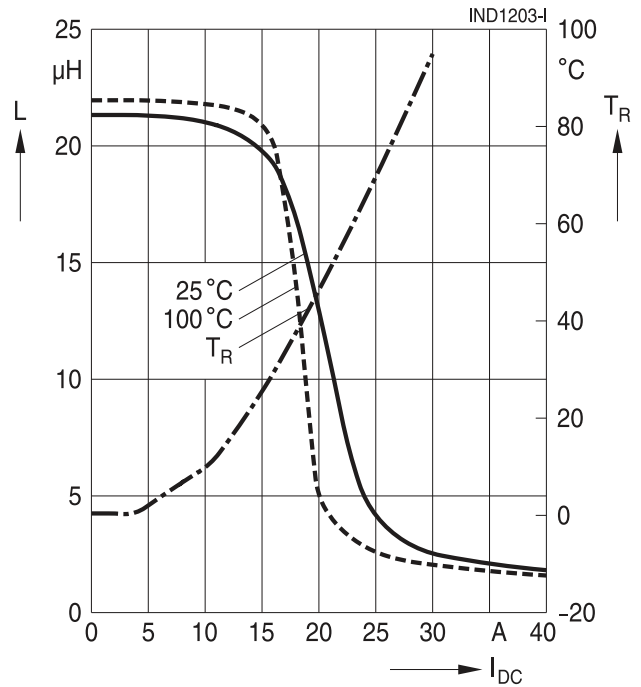


**SMD**

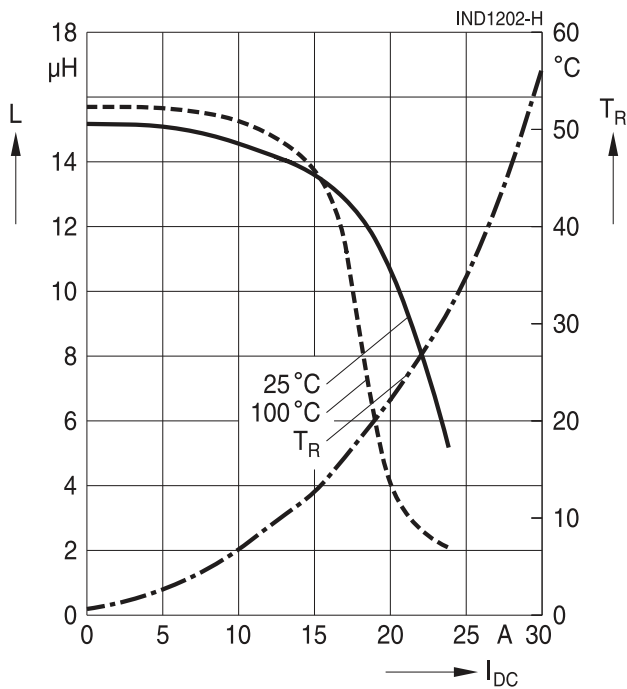
**B82559A7103A025**



**B82559A9203A025**



**B82559A7153A025**



## Cautions and warnings

- Please refer to the recommendations in the Inductor data book (latest edition) and in the data sheet.  
Particular attention should be paid to the derating coefficients.  
The derating conditions should always be observed. Temperature should always be derated in relation to the derating effect, in particular during the heating.
- If the component is to be used in an inductive circuit, check the heating during a high-frequency test. Inductive heating has a negative effect on the insulation, and the inductor has a negative effect on the insulation. Inductive heating has a negative effect on the insulation.  
Washing with water may damage the component. The component is not suitable for ultrasonic cleaning (e.g. ultrasonic cleaning). The maximum voltage, the maximum current and the maximum frequency, which may lead to reduced reliability, are limited.
- The following information should be observed if the component is used in a mechanical application:  
Maximum winding material thickness should be observed. The effective area of the winding should be observed. This area can have a deleterious effect on electrical properties, and in extreme cases can damage the component mechanically.  
It is necessary to check the heating material used during the test. The insulation should be observed.  
The effect of the winding material can change the high-frequency behavior of the component.
- Ferrite is a brittle dielectric material. This can cause the ferrite material to flake, leading to leakage of the ferrite.
- Encapsulation of the component, including the use of a component in a circuit, can not be carried out by the component.

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Release 2018-10